

SMD ■ Mini Top LEDs 65-21-Y2SC-A0R1S2B7E-2T8-AM



Features

- P-LCC-2 package.
- Colorless clear resin.
- Wide viewing angle 120°.
- Inner reflector and white package.
- Brightness: 112 to 280 mcd at 20mA.
- Qualification according to AEC-Q101 rev C.
- Precondition: Bases on JEDEC J-STD 020D Level 3.
- Automotive reflow profile (IR reflow or wave soldering)

Applications

- Automotive backlighting or indicator: Dashboard, switch, audio and video equipments...etc.
- Backlight: LCD, switches, symbol, mobile phone and illuminated advertising.
- Display for indoor and outdoor application.
- Ideal for coupling into light guides.
- Substitution of traditional light.
- Optical indicator.
- General applications.

Device Selection Guide

Chip Materials	Emitted Color	Resin Color
AlGaInP	Brilliant Yellow	Water Clear

Absolute Maximum Ratings (Ta=25 °C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	10	V
Forward Current	I_F	30	mA
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	60	mA
Power Dissipation	P_d	60	mW
Junction Temperature	T_j	125	
Operating Temperature	T_{opr}	-40 ~ +100	
Storage Temperature	T_{stg}	-40 ~ +110	
Thermal Resistance	$R_{th\ J-A}$	400	K/W
	$R_{th\ J-S}$	180	K/W
ESD (Classification acc. AEC Q101)	ESD_{HBM}	2000	V
	ESD_{MM}	200	V
Soldering Temperature	T_{sol}	Reflow Soldering : 260 for 30 sec. Hand Soldering : 350 for 3 sec.	

Electro-Optical Characteristics (Ta=25 °C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I_v	112	---	280	mcd	$I_F = 20\text{mA}$
Viewing Angle	$2\theta_{1/2}$	---	120	---	deg	$I_F = 20\text{mA}$
Peak Wavelength	λ_p	---	595	---	nm	$I_F = 20\text{mA}$
Dominant Wavelength	λ_d	585.5	---	594.5	nm	$I_F = 20\text{mA}$
Spectrum Radiation Bandwidth	$\Delta\lambda$	---	15	---	nm	$I_F = 20\text{mA}$
Forward Voltage	V_F	1.7	---	2.4	V	$I_F = 20\text{mA}$
Reverse Current	I_R	---	---	10	μA	$V_R = 10\text{V}$

Note:

1. Tolerance of Luminous Intensity: $\pm 11\%$
2. Tolerance of Dominant Wavelength: $\pm 1\text{nm}$
3. Tolerance of Forward Voltage: $\pm 0.1\text{V}$

Bin Range of Luminous Intensity

Bin	Min	Max	Unit	Condition
R1	112	140	mcd	$I_F = 20\text{mA}$
R2	140	180		
S1	180	224		
S2	224	280		

Note:

Tolerance of Luminous Intensity: $\pm 11\%$

Bin Range of Dominant Wavelength

Bin Code		Min.	Max.	Unit	Condition
A0	D3	585.5	588.5	nm	I _F =20mA
	D4	588.5	591.5		
	D5	591.5	594.5		

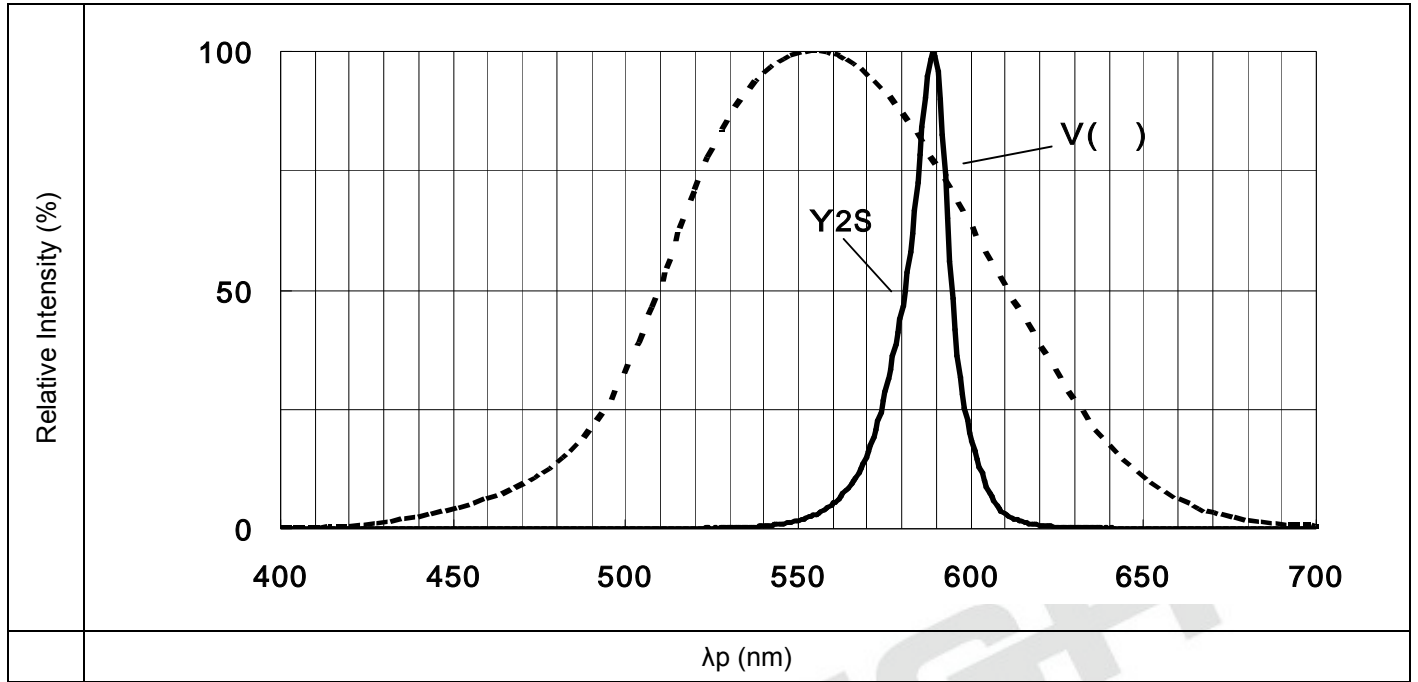
Note:

Tolerance of Dominant Wavelength: ±1nm

EVERLIGHT

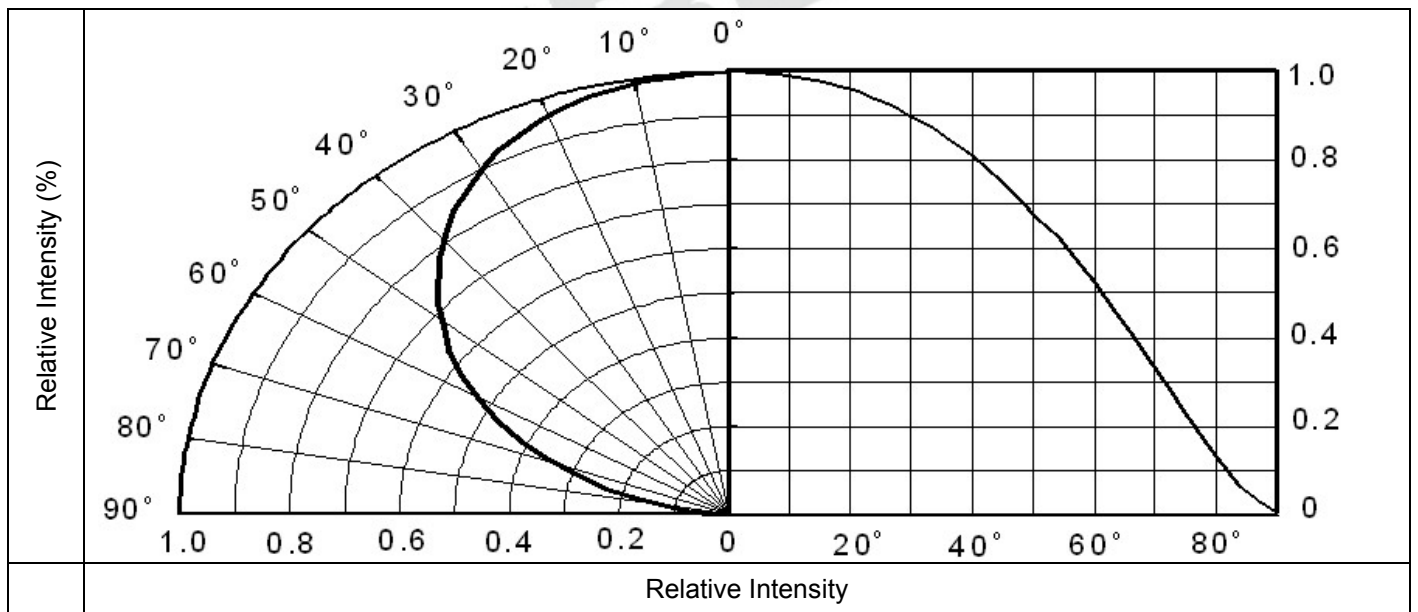
Typical Electro-Optical Characteristics Curves

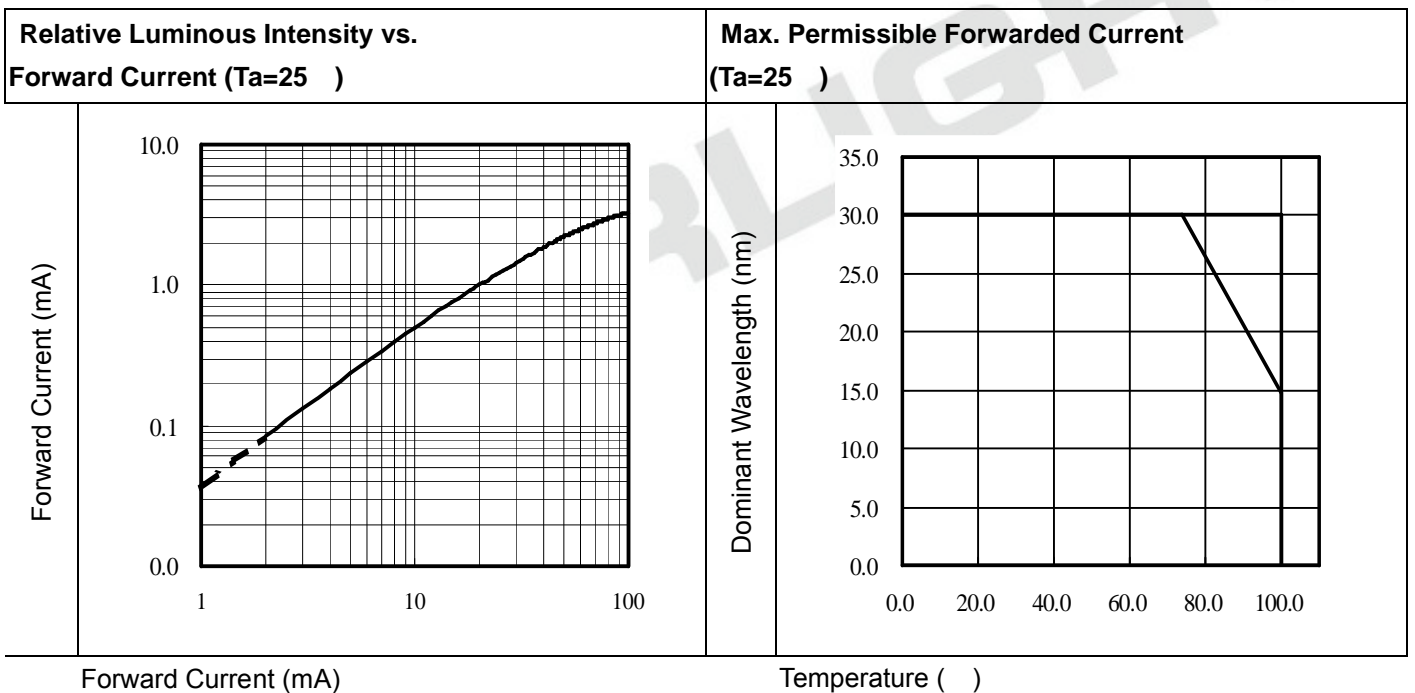
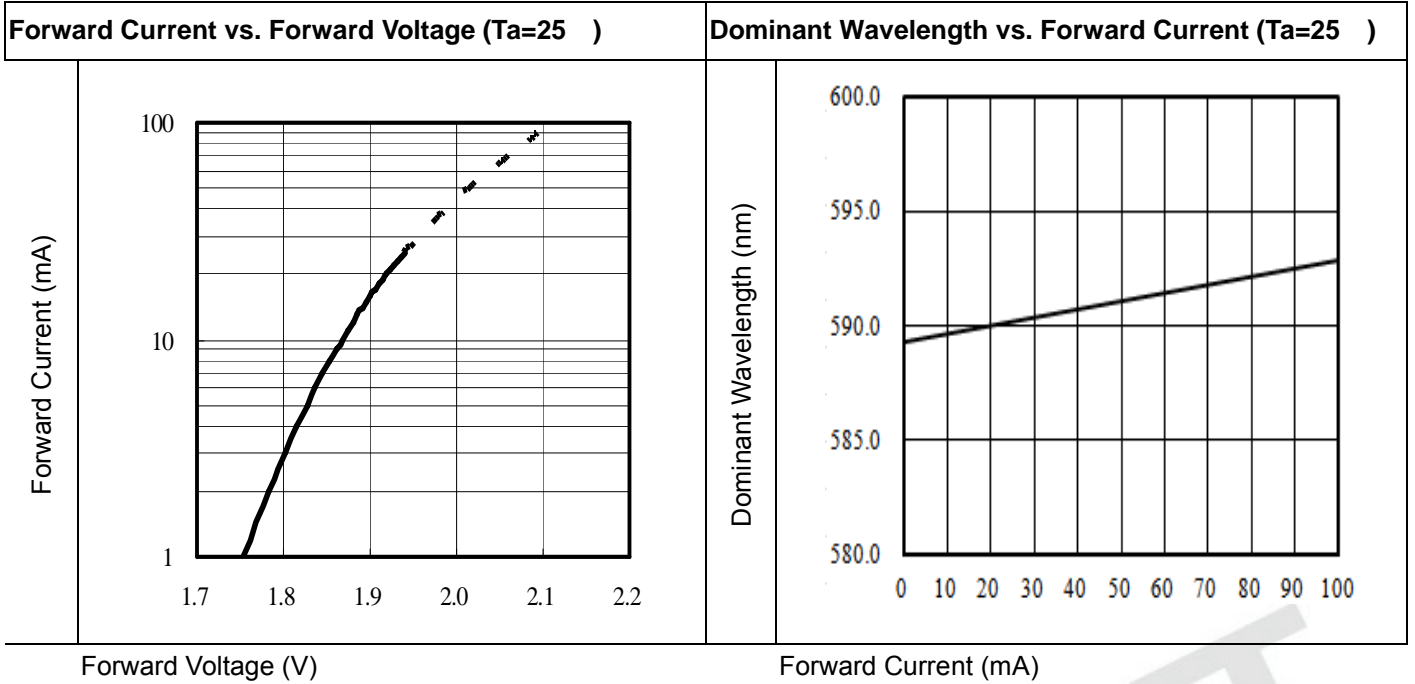
Typical Curve of Spectral Distribution



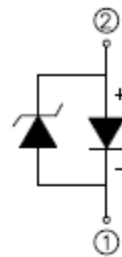
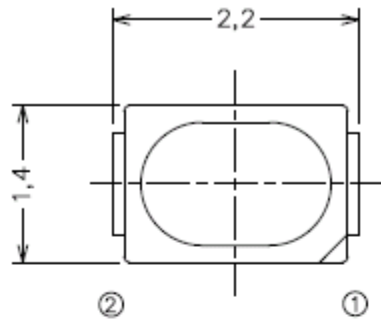
Note: $V(\lambda)$ =Standard eye response curve; $I_F = 20\text{mA}$

Diagram Characteristics of Radiation

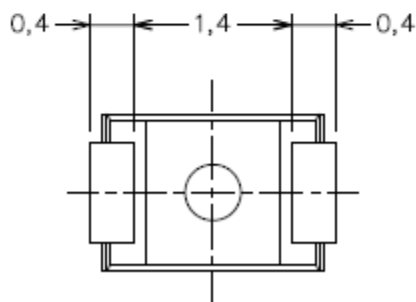
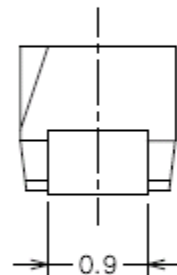
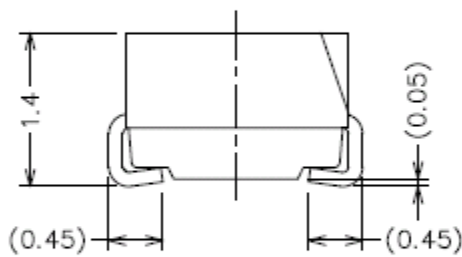




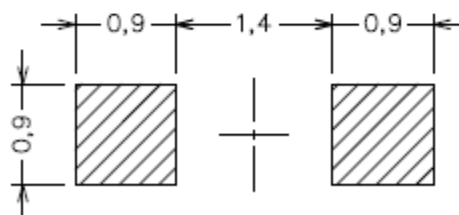
Package Dimension



Polarity



Bot. view



Soldering patterns

Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

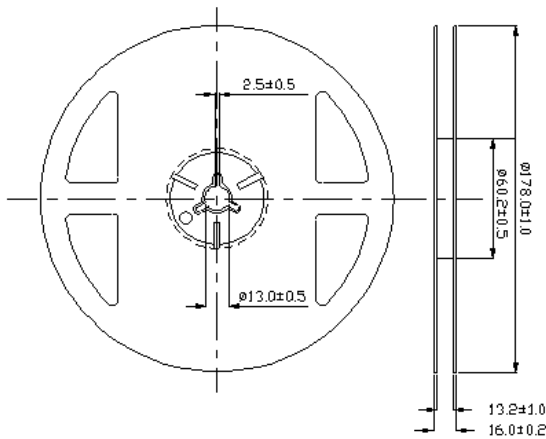
Moisture Resistant Packing Materials

Label Explanation

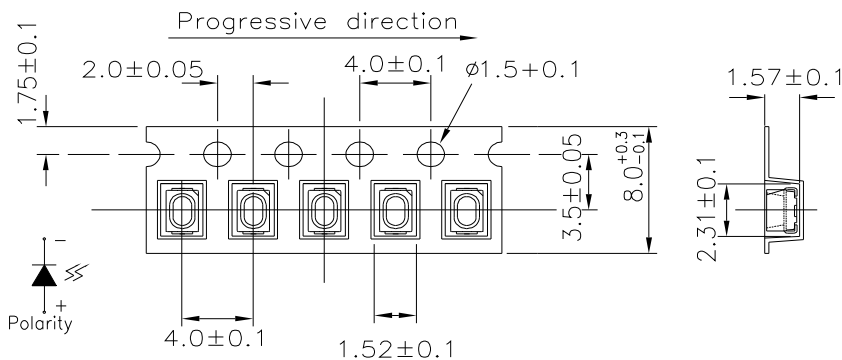


- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

Reel Dimensions

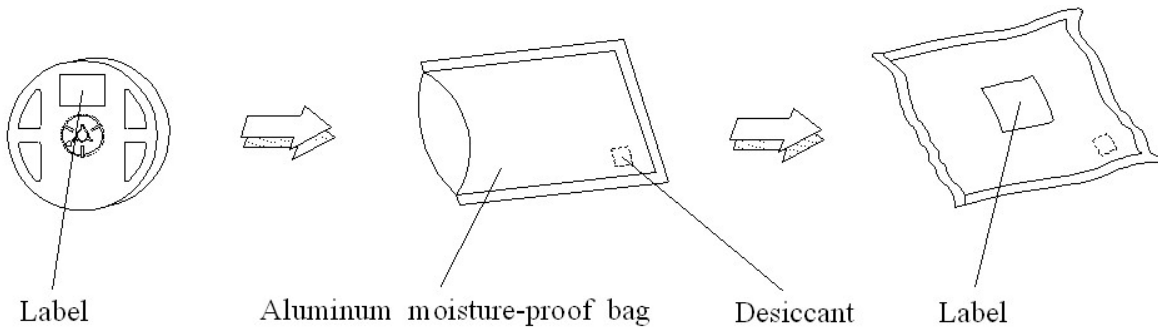


Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel



Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Moisture Resistant Packing Process

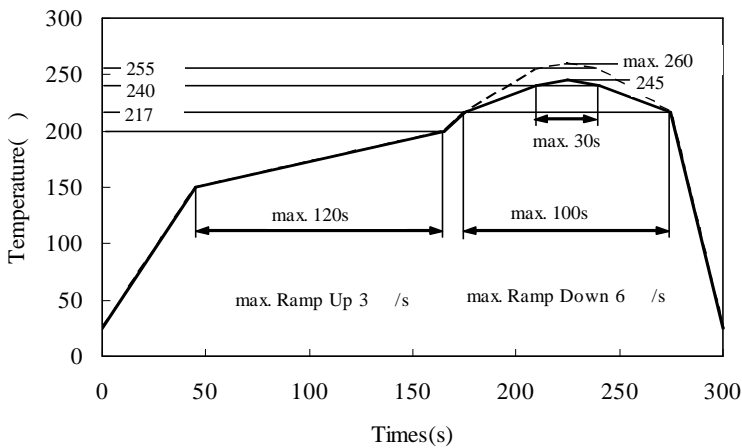


Note: Tolerances unless mentioned $\pm 0.1\text{mm}$. Unit = mm

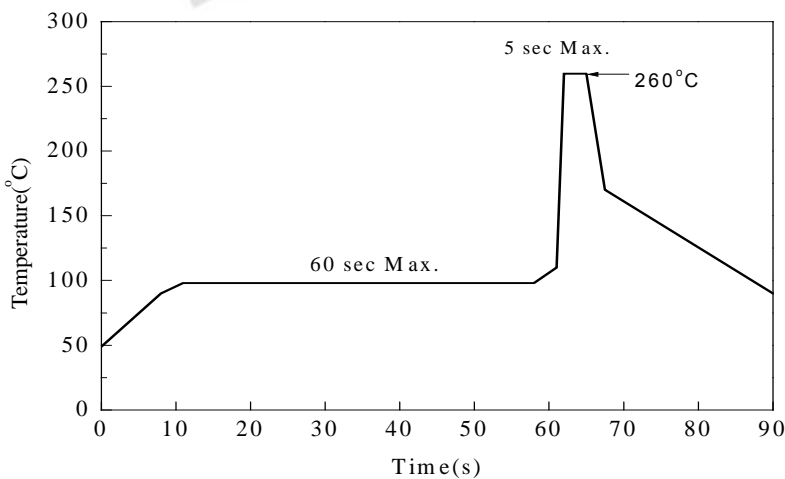
Precautions for Use

1. Soldering Condition (Reference: IPC/JEDEC J-STD-020D)

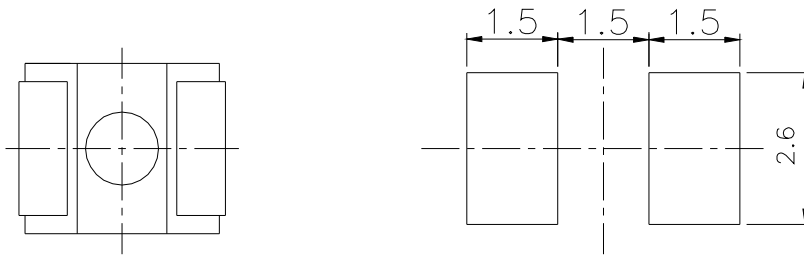
a. IR reflow



b. Wave soldering reflow



(B) Recommend soldering pad



Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

2. Current limiting

A resistor should be used to limit current spikes that can be caused by voltage fluctuations. Otherwise damage could occur.

3. Storage

3.1 Moisture proof bag should only be opened immediately prior to usage.

3.2 Environment should be less than 30 °C and 60% RH when moisture proof bag is opened.

3.3 After opening the package MSL Conditions stated on page 1 of this spec should not be exceeded.

3.4 If the moisture sensitivity card indicates higher than acceptable moisture, the component should be baked at min. 60deg +/-5deg for 24 hours.

4. Iron Soldering

Hand soldering is not recommended for regular production. These guidelines are for rework only. Soldering iron tip should contact each terminal no more than 3 sec at 350 °C, using soldering iron with nominal power less than 25W. Allow min. 2 sec. between soldering intervals.

5. Usage

Do not exceed the values given in this specification.

Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.